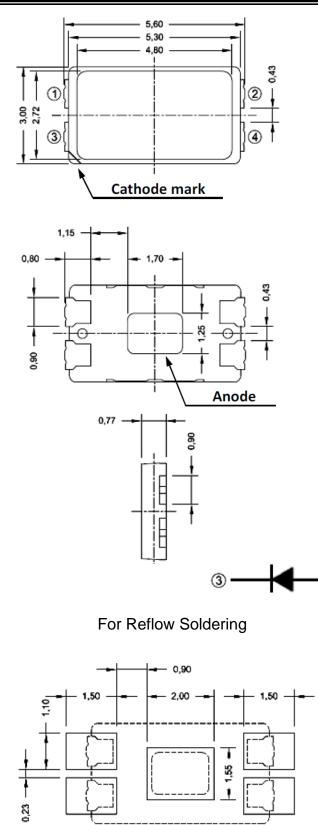
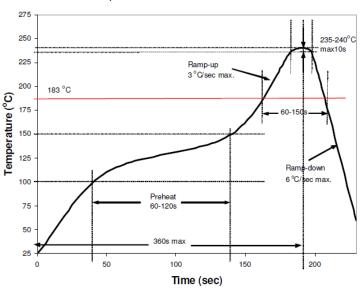
Power Warm White Surface Mount Device

Part Number: 62-217AWW2C1H

Package outlines & Re-flow Profile



■Reflow Temp/Time



■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 15W, and temperatures should be controllable.Surface temperature of the device should be under 230°C.

ITEM	MATERIALS	
Resin (mold)	Ероху	
Lens color	Yellow Diffused	
Printed circuit board	BT	
Emitted color	Warm White	
Material	InGaN	

NOTES:

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- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ± 0.1 mm (0.004inch) unless otherwise noted.
- 3. Polarity referring onto the cathode mark is reversed on the red.

Part Number: 62-217AWW2C1H

ELECTRO-OPTICAL CHARACTERISTICS

(T_A=25°C)

Parameter	Test	Symbol	Value		Unit	
	Condition		MIN. TYP.	MAX.		
Viewing angle at 50% I_V	l⊧=60mA	2 <i>                                    </i>	120		Deg	
Forward voltage	l⊧=60mA	V _F	2.9	3.3	V	
Luminous Flux	I⊧=60mA	Flux	25		Lm	
Correlated Color Temperature	l⊧=60mA	ССТ	4000		К	
Color Rending Index	I _F =60mA	CRI	80			
Pulse Forward Current (Pulse Width \leq 10msec, and duty \leq 1/10)	l⊧=60mA	I _{FP}	240		mA	
Absolute maximum ratings				(TA	=25°C)	
Parameter	Symbol	V	alue		Unit	
Forward current	IF		120		mA	
Reverse voltage	V _R		5		V	
Reverse current (Zener Diode)	I _R		0.5		μΑ	
Power dissipation	wer dissipation P _D		0.4		W	
Operating temperature range	Тор	-4(-40 ~+85		°C	
Storage temperature range	Tstg	-40	-40 ~+100		°C	

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Bin Range

V _F Rank	Condition	Min.	Max.
1	I _F = 60 mA	2.9	3.0
2		3.0	3.1
3		3.1	3.2
4		3.2	3.3

	Luminous Flux Rank	Condition	Min.	Max.
_	VD		20	22.5
	VE	I _F = 60 mA	22.5	25
	VF		25	28

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Bin Range

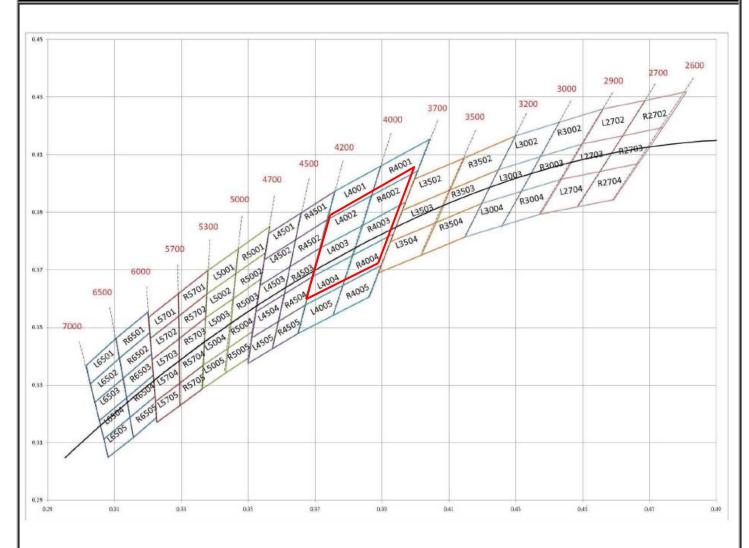
ССТ	CIE Rank	CIE X	CIE Y		CIE X	CIE Y
		0.3758	0.3973		0.3896	0.4061
	L4001	0.3736	0.3874	R4001	0.3869	0.3958
	L4001	0.3869	0.3958	R4001	0.4006	0.4044
		0.3896	0.4061		0.4042	0.4153
		0.3736	0.3874		0.3869	0.3958
	L4002	0.3714	0.3775	R4002	0.3842	0.3855
	L4002	0.3842	0.3855	114002	0.397	0.3935
		0.3869	0.3958		0.4006	0.4044
	L4003	0.3714	0.3775	R4003	0.3842	0.3855
4000		0.3692	0.3677		0.3813	0.3751
4000		0.3813	0.3751		0.3934	0.3825
		0.3842	0.3855		0.397	0.3935
	L4004 -	0.3692	0.3677	R4004	0.3813	0.3751
		0.367	0.3578		0.3783	0.3646
		0.3783	0.3646		0.3898	0.3716
		0.3813	0.3751		0.3934	0.3825
	L4005 -	0.367	0.3578	R4005	0.3783	0.3646
		0.3648	0.3479		0.3753	0.3541
		0.3753	0.3541		0.3862	0.3607
		0.3783	0.3646		0.3898	0.3716

Note:

- (1) Correlated color Temperature is derived from the CIE 1931Chromaticity diagram
- (2) Measurement tolerance is ± 0.01
- (3) The luminous flux tolerance is $\pm 10\%$
- (4) The Forward Voltage tolerance is $\pm 0.1V$

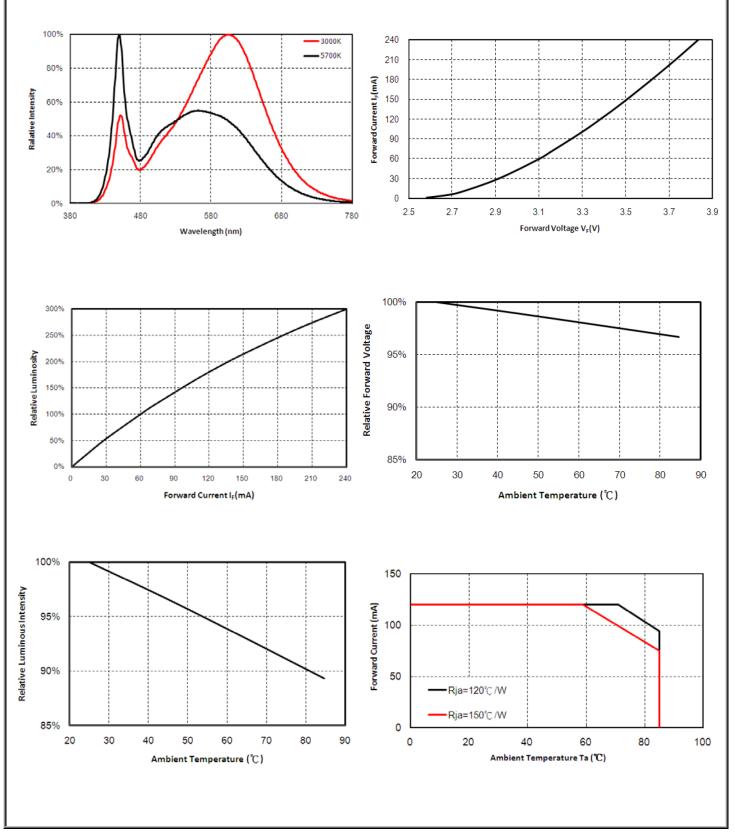
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CIE Chromaticity Diagram



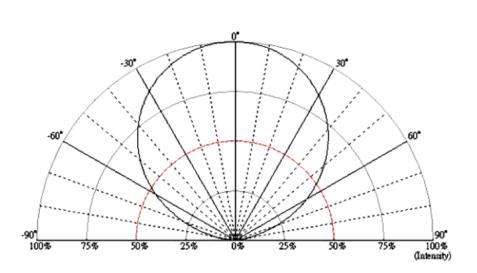
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Typical Electro-Optical Characteristic Curves



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Typical Electro-Optical Characteristic Curves



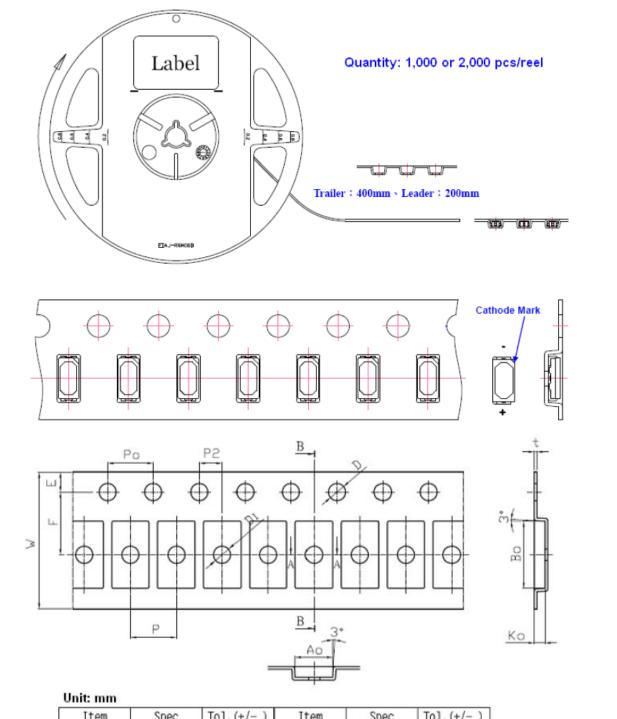
Part Number: 62-217AWW2C1H

Reliability

Item	Condition	Time/Cycle
Steady State Operating Life of Room Temperature	25℃ Operating	1000 Hrs
Steady State Operating Life of Low Temperature -40 $^\circ\! \mathbb{C}$	-40°⊖ Operating	1000 Hrs
Steady State Operating Life of High Temperature 60 $^\circ\!\mathbb{C}$	60°C Operating	1000 Hrs
Steady State Operating Life of High Temperature 85° C	85℃ Operating	1000 Hrs
Low temperature storage -40°C	-40°C Storage	1000 Hrs
High temperature storage 100℃	100°⊖ Storage	1000 Hrs
Steady State Operating Life of High Humidity Heat 60°⊖90%	60℃/90% Operating	1000 Hrs
Steady State Pulse Operating Life Condition	25℃ 10Hz duty=1/10 Operating	200 Cycles
Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60℃, 60%RH for 52hrs Tsld max.=260 ℃ 10sec	3 Times
Heat Cycle Test (JEDEC MRC)	25℃~65℃~-10℃, 90%RH, 24hr/1cycle	10 Cycles
Thermal shock	-40°∁/20min ~5min ~ 100°∁/20min	300 Cycles

Part Number: 62-217AWW2C1H

Package



Item	Spec	Tol.(+/-)	Item	Spec	Tol.(+/-)
W	12.00	±0.10	P2	2.00	±0.05
E	1.75	±0.10	P0 x 10	40.00	±0.20
F	5.50	±0.05	t1	0.25	±0.05
D	1.50	+0.10,-0.00	A0	3.25	±0.10
D1	1.50	±0.10	BO	5.90	±0.10
P0 \ P1	4.00	±0.20	К0	0.95	±0.10

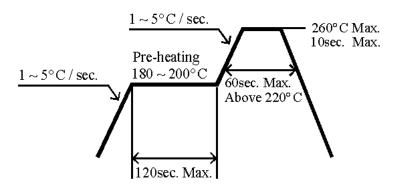
Part Number: 62-217AWW2C1H

Precautions For Use

1. Over-current proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280° C for 3 seconds within once in less than soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.